

# QSFP-DD 400GE FR4 2 km (OM3660FX102)





### **Product Features**

- QSFP-DD MSA rev5.0 compliant
- 100G Lambda MSA compliant
- 802.3cu compliant
- 400GE FR4 specification compliant
- QSFP-DD CMIS4.0 management interface compliant
- Non-hermetic package design
- 4 CWDM lanes MUX/DEMUX design
- 8 x 53.125 Gbps PAM4 electrical interface (400GAUI-8)
- Maximum power consumption 12 W
- LC duplex connector
- 425 Gbps aggregate bit rate
- Up to 2 km transmission on single mode fiber with FEC
- Single 3.3 V power supply
- · RoHS 2 compliant

## **Applications**

- 400G Ethernet
- Data center network



## 1. Description

OM3660FX102 is a transceiver module designed for 2 km optical communication applications, and it is compliant with 100G Lambda MSA standard. This module can convert 8-channel 53.125 Gbps electrical data to 4-channel 106.25 Gbps optical signals, and multiplex them into a single channel for 425 Gbps optical transmission. Similarly, it optically de-multiplexes a 425 Gbps input into 4-channel signals, and converts them to 8-channel output electrical data on the receiver side. It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference. The module offers very high functionality and feature integration, accessible via the I2C interface.

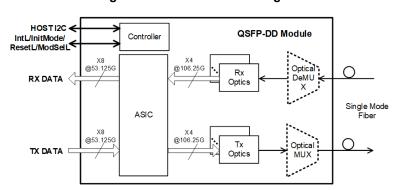


Figure 1-1 Transceiver block diagram

## 2. Pin Descriptions

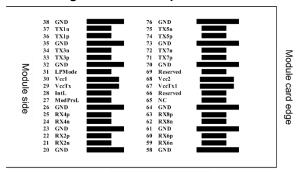
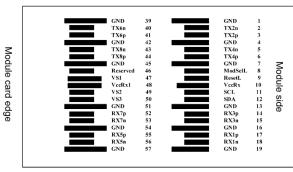


Figure 2-1 MSA-compliant connector

Top side viewed from top



Bottom side viewed from bottom

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## 3. Mechanical Specifications

127.86 127.86

Figure 3-1 OM3660FX102 mechanical dimensions

## 4. Ordering Information

Part number	Description
OM3660FX102	QSFP-DD-400GE-FR4

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